

FIG. 1

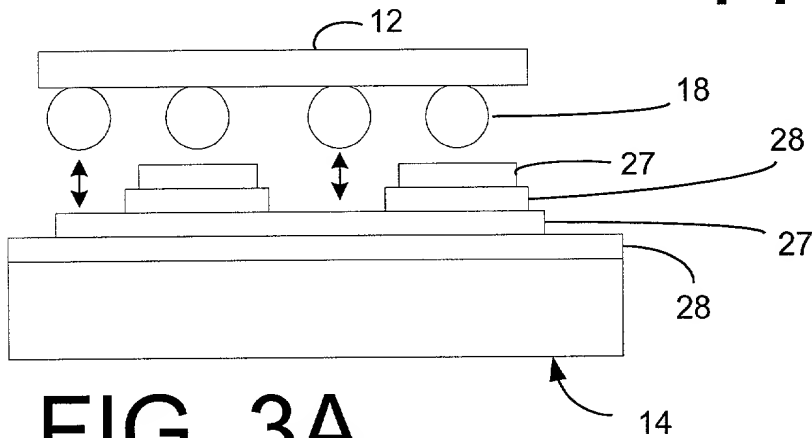


FIG. 3A

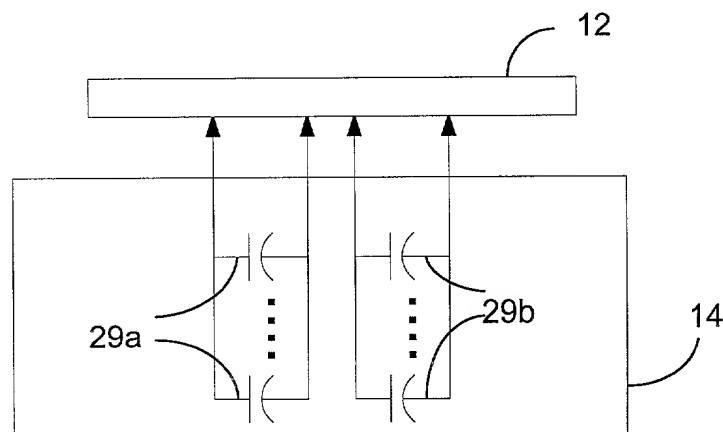


FIG. 3B

IMPROVED INTEGRATED CHIP PACKAGE
 HAVING INTERMEDIATE SUBSTRATE
 SEHAT SUTARDJA
 MP0115
 SHEET 2/3

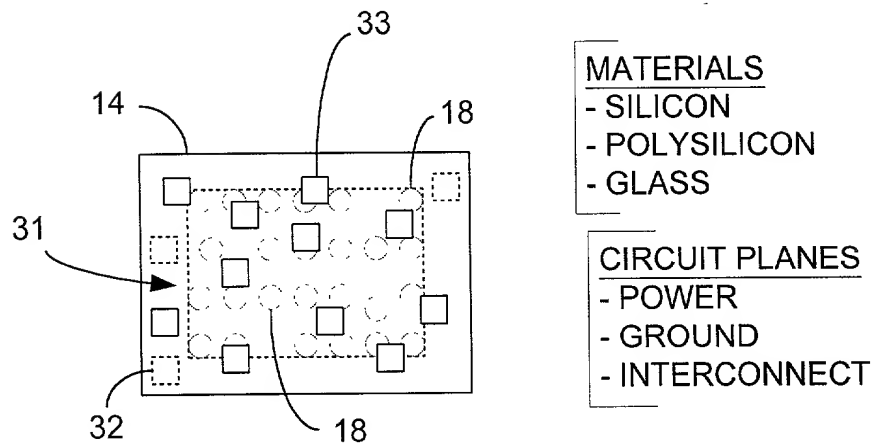


FIG. 2

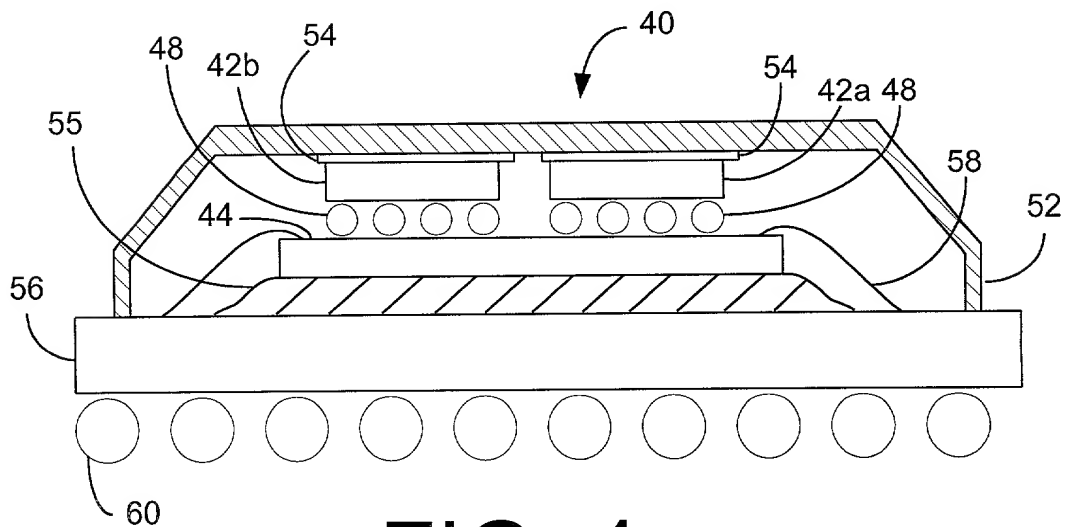


FIG. 4

IMPROVED INTEGRATED CHIP PACKAGE
HAVING INTERMEDIATE SUBSTRATE
SEHAT SUTARDJA
MP0115
SHEET 3/3

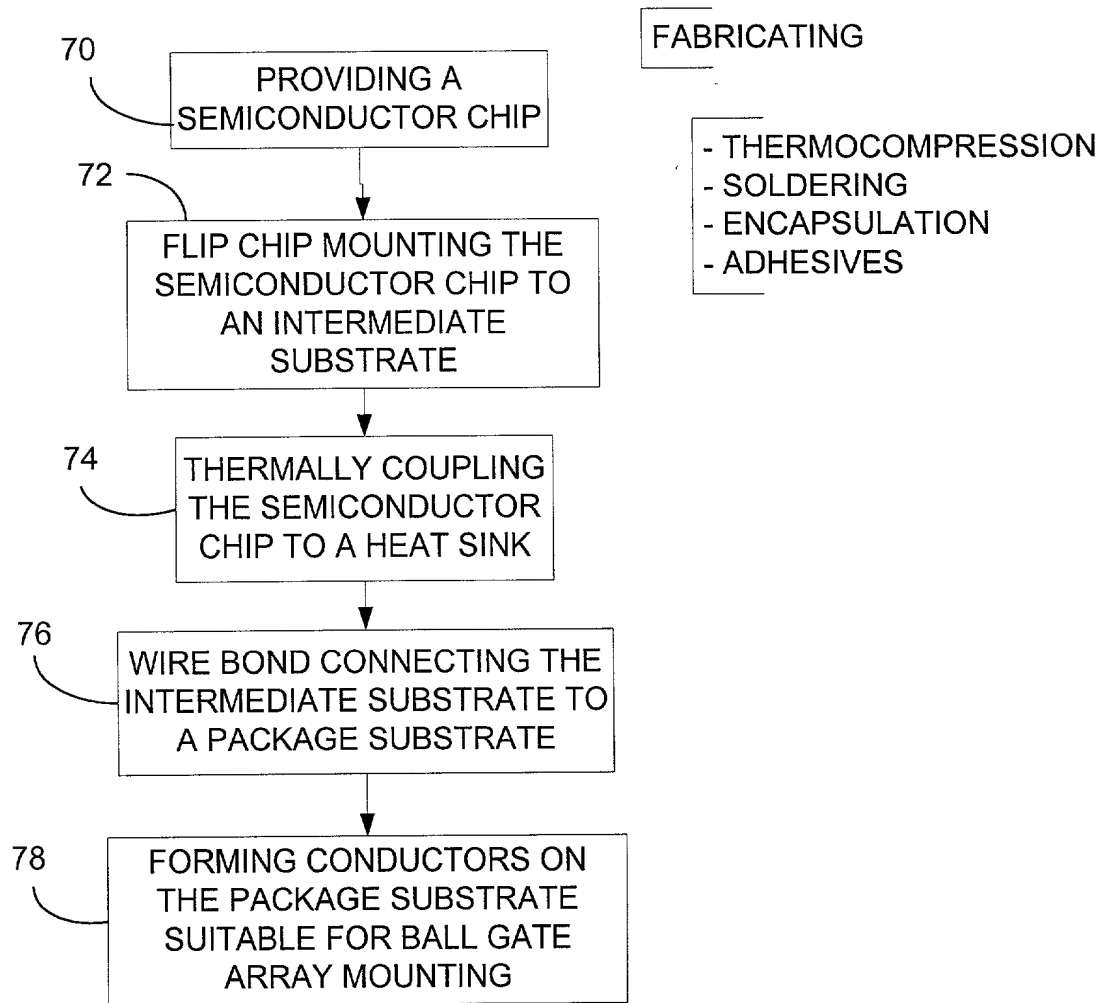


FIG. 5